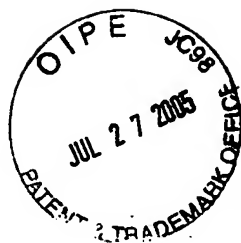


IFW



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Hiroshi KAWAZOE et al.**

Group Art Unit: **1753**

Serial No.: **10/505,416**

Filed: **June 13, 2005**

Confirmation No.: **7425**

For: **SUPPORT UNIT FOR MICROFLUIDIC SYSTEM AND
MANUFACTURING METHOD THEREOF**

Attorney Docket Number: **042717**

Customer Number: **38834**

REQUEST FOR CORRECTED FILING RECEIPT

Mail Stop: Missing Parts

Commissioner for Patents

P. O. Box 1450

Alexandria, VA 22313-1450

Date: July 27, 2005

Sir:

Please supply the undersigned attorney with a corrected filing receipt for the above-identified application. The undersigned also respectfully requests that the Patent and Trademark Office records be amended to reflect the correction.

In reviewing the Official Filing Receipt, we noted errors in the **First Inventor's Information** and the **Title**. And we also noted that the **Assignee's Information** was not recorded. The Second Inventor's Information should read --Hiroshi KAWAZOE, **Tsukuba-shi, JAPAN**-- and the Title should read --MICRO FLUID SYSTEM SUPPORT UNIT AND MANUFACTURING METHOD THEREOF--. Also, the Assignee's Information should read --**HITACHI CHEMICAL CO., LTD., Tokyo, JAPAN**--. A copy of the Declaration, the PCT

Request for Corrected Filing Receipt
10/505,416
042717



Publication and the **Assignment** are enclosed which indicate the correct information. We are also enclosing a copy of the filing receipt with the corrections highlighted.

In the event any fees are required in connection with this paper, please charge Deposit Account No. 50-2866.

Respectfully submitted,

WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP

A handwritten signature in black ink, appearing to read "Stephen G. Adrian".

Stephen G. Adrian

Attorney for Applicants

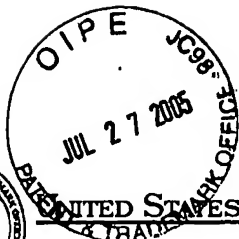
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Enclosures: Official Filing Receipt; Declaration; PCT Publication; Assignment



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APPL NO.	FILING OR 371 (c) DATE	ART. UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/505,416	06/13/2005	1753	1634	042717	12	16	6

38834

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JUN 29 2005

CONFIRMATION NO. 7425

FILING RECEIPT



OC000000016353614

Date Mailed: 06/24/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

:--Tsukuba-shi--:

Hiroshi Kawazoe, Haraki, JAPAN;
 Akishi Nakaso, Oyama-shi, JAPAN;
 Shigeharu Arike, Tochigi, JAPAN;

Please Insert { Assignment for Published Patent Application
 :--HITACHI CHEMICAL CO., LTD., Tokyo, JAPAN--:

Power of Attorney: The patent practitioners associated with Customer Number 38834.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP03/02066 02/25/2003

Foreign Applications

JAPAN 2002-48580 02/25/2002
 JAPAN 2002-292978 10/04/2002
 JAPAN 2003-46414 02/24/2003

Projected Publication Date: 09/29/2005

Non-Publication Request: No

Early Publication Request: No

Title

Micro fluid system support and manufacturing method thereof

Preliminary Class

204

~~Unit~~
Please Insert**PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES**

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
HITACHI CHEMICAL CO., LTD.

(Insert ASSIGNEE's
 Name(s) Address(es))

1-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0449 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned
 ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title
 and interest to the invention entitled

(Title of Invention)

**SUPPORT UNIT FOR MICROFLUIDIC SYSTEM AND MANUFACTURING
 METHOD THEREOF**

(*If the assignment is
 being filed after the
 filing of the
 application, this
 section must be
 completed)

for which application for Letters Patent of the United States was executed on even date herewith
 unless otherwise indicated below:

* filed on _____ Serial No. _____

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial
 number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any
 continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for
 which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any
 continuation, divisional, reissue or reexamination applications thereof and also to execute separate
 assignments in connection with such applications as the ASSIGNEE may deem necessary or
 expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference,
 litigation, or other legal proceeding which may be declared concerning this application or any
 continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued
 thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing
 evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

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NO LEGALIZATION REQUIRED

(19) 世界知的所有権機関
国際事務局(43) 国際公開日
2003年8月28日 (28.08.2003)

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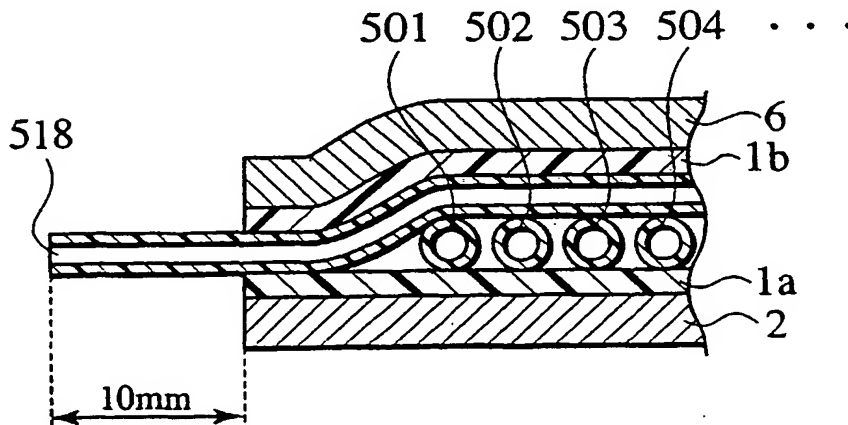
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B81C 5/00, G01N 37/00, B01J 19/00
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特願2002-292978 2002年10月4日 (04.10.2002) JP
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- (84) 指定国 (広域): ARIPO 特許 (GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), ユーラシア特許 (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), ヨーロッパ特許 (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IT, LU, MC, NL, PT, SE, SI, SK, TR), OAPI 特許 (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- 添付公開書類:
— 国際調査報告書
— 請求の範囲の補正の期限前の公開であり、補正書受領の際には再公開される。

[続葉有]

(54) Title: MICRO FLUID SYSTEM SUPPORT UNIT AND MANUFACTURING METHOD THEREOF

(54) 発明の名称: マイクロ流体システム用支持ユニット及びその製造方法



(57) Abstract: A micro fluid system support unit includes a first support body (2), a first adhesive layer (1a) arranged on the surface of the first support body (2), a first hollow filament group consisting of a plurality of hollow filaments (501 to 508) arranged with an arbitrary shape on the surface of the first adhesive layer (1a), a second hollow filament group consisting of a plurality of hollow filaments (511 to 518) arranged in the direction orthogonal to the first hollow filament group, a second adhesive layer (1b) arranged on the surface of the second hollow filament group, and a second

support body (6) arranged on the surface of the second adhesive layer (1b). The first and the second hollow filament group constitute a flow passage layer.

[続葉有]